

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



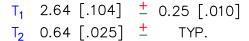




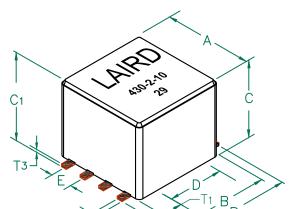
PHYSICAL DIMENSIONS:

29F0430-2SR-10

UNCONTROLLED DOCUMENT



 T_3 0.38 [.015] $^{\pm}$ TYP.



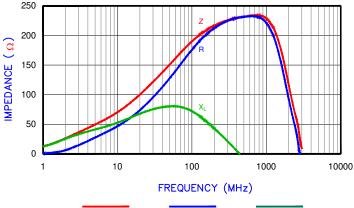
ELECTRICAL CHARACTERISTICS:								
Z @ 100MHz (<u>Ω</u>)		DCR (Ω)	Rated Current					
Nominal	200							
Minimum	150							
Maximum	250	0.01	8,000 mA					

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECS. 13" REELS, 450 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. REF. CARRIER TAPE SPECIFICATION # CART430-23.
- 4. TERMINATION FINISH IS 100% TIN.
- 5. THIS PART HAS NO PIN POLARITY.
- 6. OPERATION TEMPERATURE (INCLUDING SELF-HEATING) -40 ~ +125℃.

1234

|Z| , R, AND X vs. FREQUENCY



RoHS

14.22 10.54 [.560] [.415]

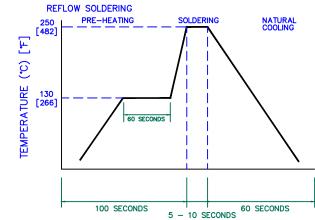
> 1.14 [.045]

9.02

.355

LAND PATTERNS FOR REFLOW SOLDERING 1.40 RECOMMENDED SOLDERING CONDITIONS REFLOW SOLDERING 250 PRE-HEATING SOLDERING CONDITIONS

3.68 [.145]



	DIMENSIONS ARE IN MM [INCHES].			This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no	l a	ird
F	ADD NOTE 6	08/30/12	QIU	copies shall be made without the written consent of Laird Tech. All		11 61
Ę	UPDATE COMPANY LOGO AND ROHS SYM	10/27/08	JRK	rights to design or invention are		
-	ADD EQUIV. CIRCUIT CHG KAPTON LABEL	10/2//06		reserved.		
D	UPDATE COMPANY LOGO	05/02/07	JRK	PROJECT/PART NUMBER:	REV	DRAWN BY:
С	UPDATE CURVE & TEST REF DATA	04/06/06	JRK	29F0430-2SR-10		JRK
В	UPDATE FORMAT ADD ROHS SYMBOL	08/27/04	JRK	DATE: 05/14/04 SCALE: NT	NTS SHEET:	
A	ORIGINAL DRAFT	05/14/04	JRK	CAD # TOOL #		1 of 2
REV	DESCRIPTION	DATE	INT		H0431	

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 5438